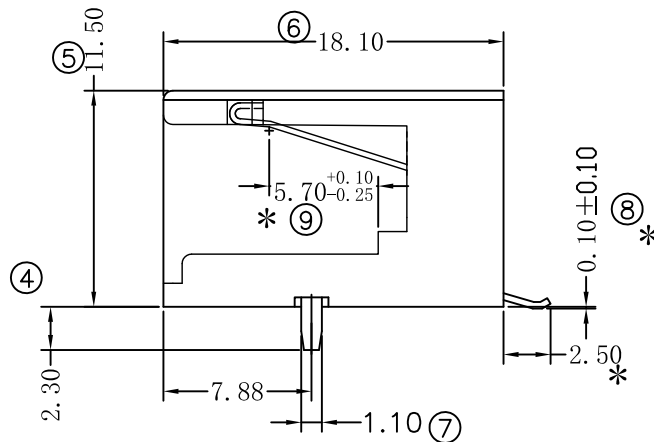
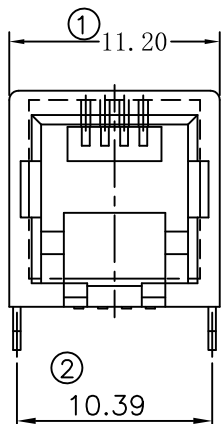


RoHS compliant



NOTES

MATERIAL

1. HOUSING MATERIAL : HIGH TEMP THERMOPLASTIC
FLAMMABILITY RATING UL94V-0.
2. CONTACT MATERIAL : PHOSPHOR BRONZE T=0.3mm.
3. PLATING : GOLD LATING OVER NICKEL IN CONTACT
TIN PLATING OVER NICKEL IN SOLDER AREA.
: FU", 3U", 6U", 15U", 30", 50".

ELECTRICAL

1. VOLTAGE RATING : 125 VAC RMS.
2. CURRENT RATING : 1.5 AMP.
3. CONTACT RESISTANCE : 40 MILLIOHMS MAX.
4. INSULATION RESISTANCE : 1000 MEGOHMS MIN @ 500V DC .
5. DIELECTRIC RESISTANCE : 1000V AC RMS 50Hz. 1MIN.

MECHANICAL

1. DURRABILITY : 750 CYCLES MIN.
2. PCB RETENTIONPRE-SOLDER : 1 LB MIN.

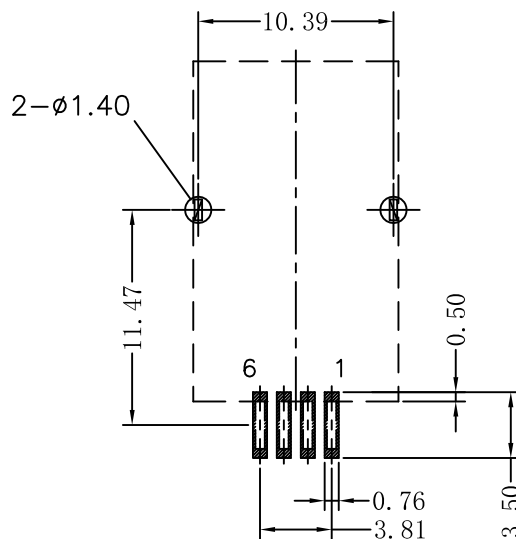
ENVIRONMENTAL:

1. STORAGE : -40°C~+85°C.
2. OPERATION : -20°C TO 75°C.

Mates With Modular Plug Conforming To FCC Part 68, Subpart F.

P/N:RJ56S-4411-030551X

- 56S RJ11 90° SMT SERIES PCB JACK
- POSITIONS (金針位置):
- 4-POSITIONS (4P)
- CONTACTS (金針根數)
- 4-CONTACTS (4C)
- PORTS (端口):
- 11-1X1
- SHIELD (屏蔽壳):
- 0=Without SHIELD (无屏蔽壳)
- IRON PEG (铁脚定位脚):
- 3-IRON Feet DIP (定位脚直插)
- HOUSING PEG (塑胶定位柱):
- 0=Without PEG (无定位柱)
- PACKING TYPE (包装):
- 1-REEL (卷带包装)
- 2-PVC TRAY (盘装)
- COLOR (颜色):
- 1-BLACK (黑色)
- 7-BLUE (蓝色)
- PLASTIC (塑料):
- 4-LCP; 5-PART
- GOLD PLATING (鍍金厚度):
- 1-1U"; 5-6U"; 6-15U"
- 7-30U"; 8-50U";



PCB LAYOUT/TOP VIEW

						GENERAL TOLERANCE		DRAWN		Gene Li		2019/11/21		X-SHUN 东莞市祥舜电子科技有限公司		DONGGUAN X-SHUN ELECTRONIC TECHNOLOGY CO., LTD	
						.X	±0.35	X.°	± 2°	CHECKE		HCB		PART NO.		RJ56S-4411-030551X	
						.XX	±0.25	.X°	± 1°	APPROVE				TITLE:		RJ11 4P4C 90° L=18.1MM SMT PCB JACK	
						.XXX	±0.15	.XX°	± 0.5°	PROJECT				REV		DRAWING NO.	
REV	ECN NO	DESCRIPTION		DATE	SIGNATURE			UNIT	mm	SCALE	1:1	SHEET	1/1	REV	A0	DRAWING NO.	
A0		NEW DESIGN		2019/11/21												RJ56S-44	